

High Power 808nm 2000mW FP Laser Diode, C-Mount LD808E2WG13

Data Sheet

Features

• 808nm Fabry-Perot cavity semiconductor laser

Optical output power: 2000mW CW

High output powerNo monitor photodiodePackage: C-Mount

Specifications ($T_C = 20^{\circ}C$)

OPTICAL CHARACTERISTICS		
Parameter	Typ.	Unit
Lasing wavelength	808±5	nm
Output power	2	W
Spectral width	≤3	nm
Emitting area width	150	um
Temperature coefficient	0.30	nm/°C
Fast axis divergence	<40	deg
Slow axis divergence	<10	deg

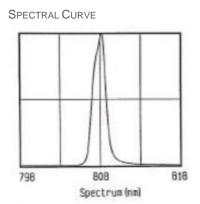
ELECTRICAL CHARACTERISTICS		
PARAMETER	Typ.	Unit
Slope efficiency	≥1.00	W/A
Threshold current	≤0.50	Α
Operating current	≤2.10	А
Operating voltage	≤2.00	V

OTHERS CHARACTERISTICS		
Parameter	Түр.	Unit
Package	C-Mount	-
Operating temperature	15 to 30	°C
Storage temperature	-40 to +60	°C
Welding temperature	≤260	°C

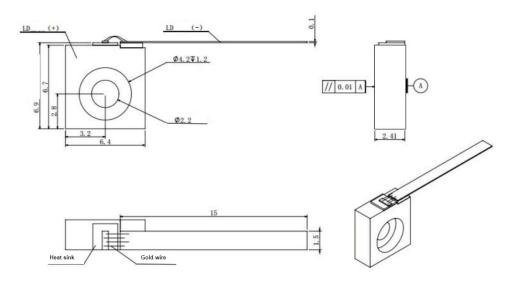
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Typical Characteristics

P-I-V CURVE 2.0 (M) (V) 1.5 1.2 3 5 0.8 0.4 1 0.0 0 3.0 1.5 D.C. Current [A]



Mechanical Outline (unit: mm)



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Additional Notes

• Do not operate the device above maximum ratings. Doing so may cause unexpected and permanent damage to the device.

- Take precautions to avoid electrostatic discharge and/or momentary power spikes. A change in the characteristics of the laser or premature failure may result.
- Proper heat sinking of the device assures stability and lifetime. Always ensure that maximum operating temperatures are not exceeded.
- Observing visible or invisible laser beams with human eye directly, or indirectly, can cause permanent damage. Use a camera to observe the laser.
- No laser device should be used in any application or situation where life or property is at risk in the event of device failure.
- Specifications are subject to change without notice. Ensure that you have the latest specifications by contacting us prior to purchase or use of the product.